# N-Channel Power MOSFET 500 V, 0.85 $\Omega$

#### Features

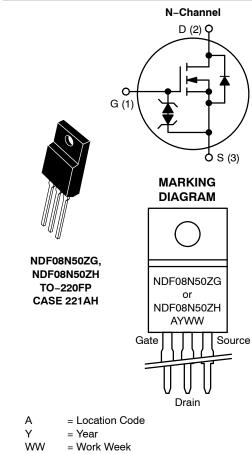
- Low ON Resistance
- Low Gate Charge
- ESD Diode-Protected Gate
- 100% Avalanche Tested
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant



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V <sub>DSS</sub>	R <sub>DS(ON)</sub> (MAX) @ 3.6 A
500 V	0.85 Ω



G, H = Pb-Free, Halogen-Free Package

#### ORDERING INFORMATION

Device	Package	Shipping
NDF08N50ZG	TO-220FP (Pb-Free, Halogen-Free)	50 Units / Rail
NDF08N50ZH	TO-220FP (Pb-Free, Halogen-Free)	50 Units / Rail

#### ABSOLUTE MAXIMUM RATINGS (T\_C = 25°C unless otherwise noted)

Rating	Symbol	NDF08N50Z	Unit
Drain-to-Source Voltage	V <sub>DSS</sub>	500	V
Continuous Drain Current $R_{\theta JC}$ (Note 1)	Ι <sub>D</sub>	8.5	А
Continuous Drain Current $R_{\theta JC}$ T <sub>A</sub> = 100°C (Note 1)	۱ <sub>D</sub>	5.4	A
Pulsed Drain Current, V <sub>GS</sub> @ 10 V	I <sub>DM</sub>	34	A
Power Dissipation	PD	35	W
Gate-to-Source Voltage	V <sub>GS</sub>	±30	V
Single Pulse Avalanche Energy, $I_D = 7.5 \text{ A}$	E <sub>AS</sub>	190	mJ
ESD (HBM) (JESD 22–A114)	V <sub>esd</sub>	3500	V
$\label{eq:RMS} \begin{array}{l} \text{RMS Isolation Voltage} \\ (t=0.3 \; \text{sec.}, \; \text{R.H.} \leq 30\%, \\ T_{\text{A}} = 25^{\circ}\text{C}) \; (\text{Figure 14}) \end{array}$	V <sub>ISO</sub>	4500	V
Peak Diode Recovery (Note 2)	dV/dt	4.5	V/ns
MOSFET dV/dt	dV/dt	60	V/ns
Continuous Source Current (Body Diode)	I <sub>S</sub>	7.5	A
Maximum Temperature for Soldering Leads	ΤL	260	°C
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	–55 to 150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Limited by maximum junction temperature

2.  $I_{SD}$  = 7.5 Å, di/dt  $\leq$  100 Å/ $\mu s,$   $V_{DD}$   $\leq$   $BV_{DSS},$   $T_{J}$  = +150°C

#### THERMAL RESISTANCE

Parameter	Symbol	NDF08N50Z	Unit
Junction-to-Case (Drain)	$R_{\theta JC}$	3.6	°C/W
Junction-to-Ambient Steady State (Note 3)	$R_{\theta JA}$	50	

3. Insertion mounted

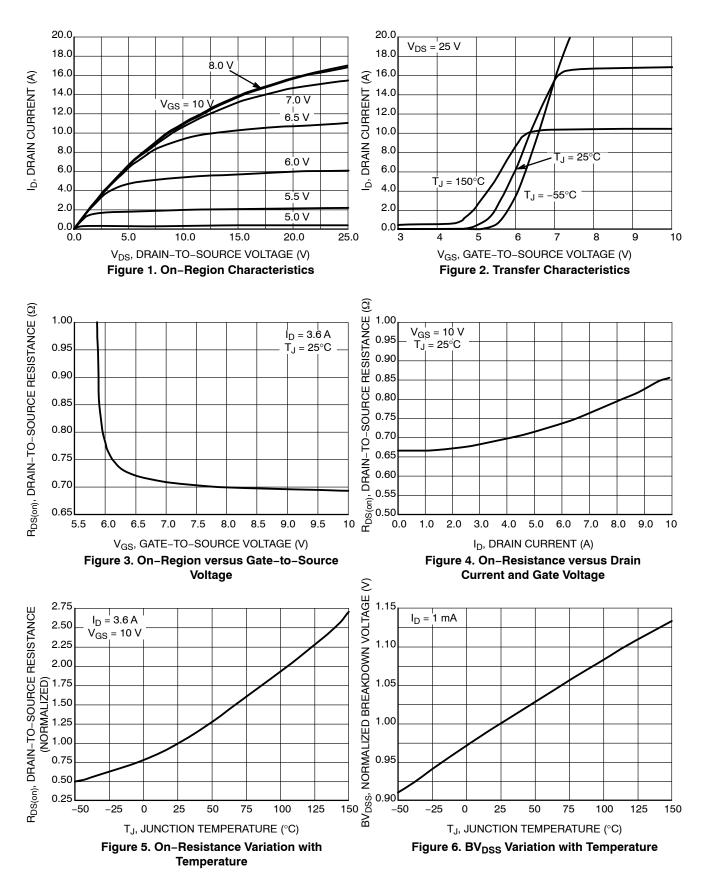
#### **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = $25^{\circ}$ C unless otherwise noted)

Characteristic	Test Conditions		Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS			-		-	-	-
Drain-to-Source Breakdown Voltage	$V_{GS}$ = 0 V, I <sub>D</sub> = 1 mA		BV <sub>DSS</sub>	500			V
Breakdown Voltage Temperature Co- efficient	Reference to 25°C, I <sub>D</sub> = 1 mA		$\Delta BV_{DSS}/\Delta T_J$		0.6		V/°C
Drain-to-Source Leakage Current	V <sub>DS</sub> = 500 V, V <sub>GS</sub> = 0 V	25°C	I <sub>DSS</sub>			1	μA
		150°C				50	1
Gate-to-Source Forward Leakage	V <sub>GS</sub> = ±20 V		I <sub>GSS</sub>			±10	μA
ON CHARACTERISTICS (Note 4)			•		-	•	
Static Drain-to-Source On-Resistance	$V_{GS}$ = 10 V, $I_{D}$ = 3.6 A		R <sub>DS(on)</sub>		0.69	0.85	Ω
Gate Threshold Voltage	$V_{DS}$ = $V_{GS}$ , $I_D$ = 100 $\mu$ A		V <sub>GS(th)</sub>	3.0	3.9	4.5	V
Forward Transconductance	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 3.75 A		9fs		6.0		S
DYNAMIC CHARACTERISTICS							-
Input Capacitance (Note 5)	V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V, f = 1.0 MHz		C <sub>iss</sub>	730	912	1095	pF
Output Capacitance (Note 5)			C <sub>oss</sub>	95	120	140	
Reverse Transfer Capacitance (Note 5)			C <sub>rss</sub>	15	27	35	
Total Gate Charge (Note 5)			Qg	16	31	46	nC
Gate-to-Source Charge (Note 5)			Q <sub>gs</sub>	3	6.2	9	1
Gate-to-Drain ("Miller") Charge (Note 5)	$V_{DD}$ = 250 V, I_D = 7.5 A, $V_{\rm GS}$ = 10 V		Q <sub>gd</sub>	8	17	25	
Plateau Voltage					6.3		V
Gate Resistance			R <sub>g</sub>		3.0		Ω
RESISTIVE SWITCHING CHARACTER	RISTICS						
Turn-On Delay Time			t <sub>d(on)</sub>		13		ns
Rise Time	$V_{DD}$ = 250 V, I_D = 7.5 A, $V_{GS}$ = 10 V, R_G = 5 $\Omega$		t <sub>r</sub>		23		
Turn-Off Delay Time			t <sub>d(off)</sub>		31		1
Fall Time			t <sub>f</sub>		29		1
SOURCE-DRAIN DIODE CHARACTE	<b>RISTICS</b> (T <sub>C</sub> = 25°C unless oth	nerwise no	ted)		•		
			,		1	1	

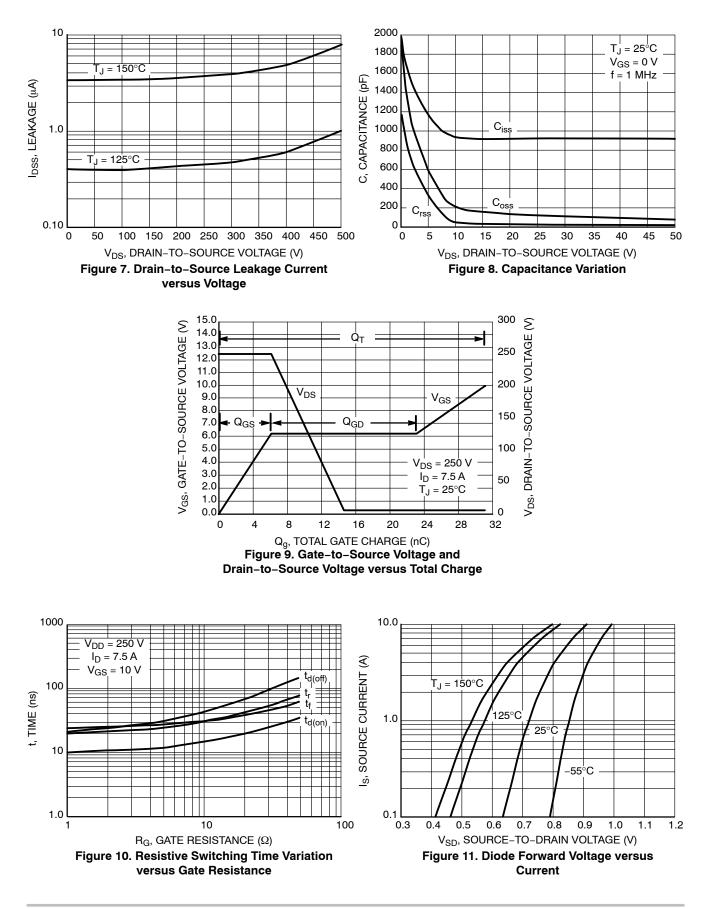
Diode Forward Voltage	$I_{\rm S}$ = 7.5 A, $V_{\rm GS}$ = 0 V	V <sub>SD</sub>		1.6	V
Reverse Recovery Time	V <sub>GS</sub> = 0 V, V <sub>DD</sub> = 30 V	t <sub>rr</sub>	295		ns
Reverse Recovery Charge	I <sub>S</sub> = 7.5 A, di/dt = 100 A/μs	Q <sub>rr</sub>	1.85		μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
4. Pulse Width ≤ 380 µs, Duty Cycle ≤ 2%.
5. Guaranteed by design.

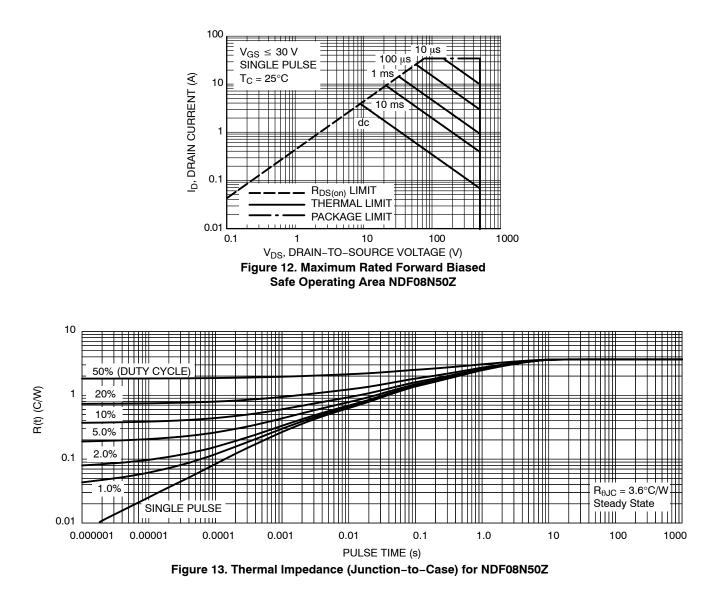
#### **TYPICAL CHARACTERISTICS**

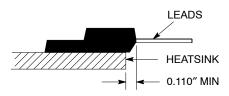


#### **TYPICAL CHARACTERISTICS**



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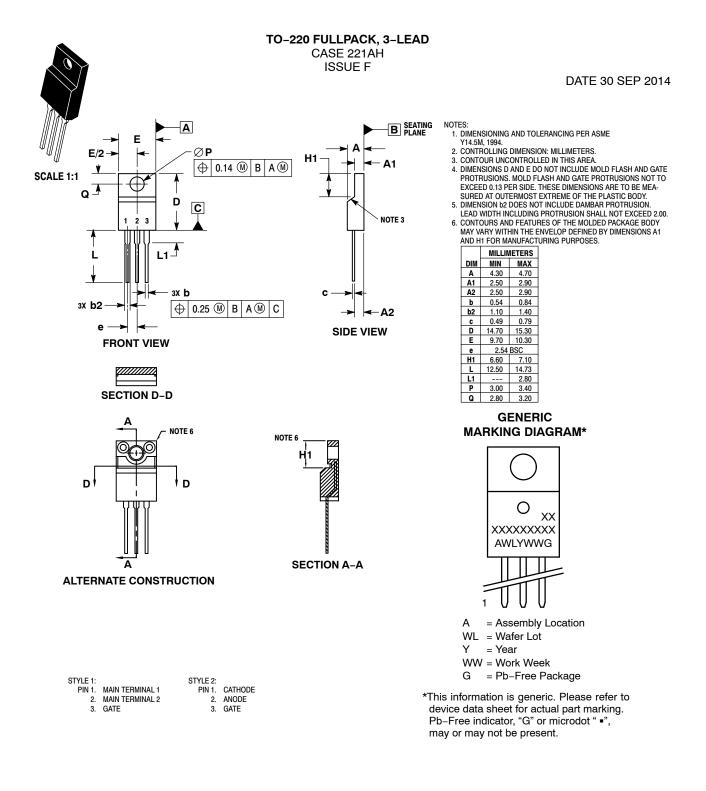


#### Figure 14. Isolation Test Diagram

Measurement made between leads and heatsink with all leads shorted together.

\*For additional mounting information, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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